

Vishay Siliconix

# N-Channel 25 V (D-S) MOSFET



PRODUCT SUMMARY			
V <sub>DS</sub> (V)	25		
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.00061		
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00082		
Q <sub>g</sub> typ. (nC)	54		
I <sub>D</sub> (A) <sup>a</sup>	337		
Configuration	Single		

#### **FEATURES**

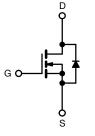
- TrenchFET® Gen IV power MOSFET
- Very low R<sub>DS</sub> x Q<sub>g</sub> figure-of-merit (FOM)



- Leadership R<sub>DS(on)</sub> minimizes power loss from conduction
- 100 % R<sub>a</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Battery management
- DC/DC converters
- · Hot swap switch
- OR-ing FET



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SIRA20DDP-T1-UE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	25	V	
Gate-source voltage		V <sub>GS</sub>	+16 / -12	v	
	T <sub>C</sub> = 25 °C		337		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1 .	270		
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	83 b, c		
	T <sub>A</sub> = 70 °C	1	66 b, c		
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	500	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		94.5		
	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	5.6 <sup>b, c</sup>		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	90		
Single pulse avalanche energy	L = 0.1 IIII	E <sub>AS</sub>	405	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		104		
	T <sub>C</sub> = 70 °C	$P_{D}$	67	w	
	T <sub>A</sub> = 25 °C		6.3 b, c	VV	
	T <sub>A</sub> = 70 °C		4 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) <sup>c</sup>			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	$R_{thJA}$	15	20	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	0.9	1.2	C/VV	

#### Notes

a. T<sub>C</sub> = 25 °C b. Surface mounted on 1" x 1" FR4 board

Surface mounted on 1 x 1 1 nd board
t = 10 s
See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
Maximum under steady state conditions is 54 °C/W



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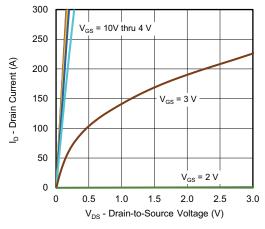
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•		•		
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	25	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	20	-	1400	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-4.5	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1.0	-	2.1	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +16 \text{ V} / -12 \text{ V}$	-	-	± 100	nA	
-		$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	Ω	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10		
<b>D</b>		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	0.00048	0.00061		
Drain-source on-state resistance a	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	-	0.00063	0.00082		
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 100 A	-	200	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	9340	-	pF	
Output capacitance	C <sub>oss</sub>		-	3510	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	180	-		
		$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	121	186	nC	
Total gate charge	Qg		-	54	81		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	-	27	-		
Gate-drain charge	Q <sub>gd</sub>		-	6.7	-		
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V	-	89	-	1	
Gate resistance	$R_g$	f = 1 MHz	0.2	1.1	2.2	Ω	
Turn-on delay time	t <sub>d(on)</sub>	$\begin{split} V_{DD} &= 10 \text{ V}, \text{ R}_L = 0.5 \Omega, \text{ I}_D \cong 20 \text{ A}, \\ V_{GEN} &= 10 \text{ V}, \text{ R}_g = 1 \Omega \end{split}$	-	17	35		
Rise time	t <sub>r</sub>		-	8	15		
Turn-off delay time	t <sub>d(off)</sub>		-	55	110	1	
Fall time	t <sub>f</sub>		-	7	15	1	
Turn-on delay time	t <sub>d(on)</sub>		-	57	100	ns	
Rise time	t <sub>r</sub>	$\begin{split} V_{DD} = 10 \text{ V, } R_L = 0.5 \ \Omega, \ I_D &\cong 20 \text{ A,} \\ V_{GEN} = 4.5 \text{ V, } R_g = 1 \ \Omega \end{split}$	-	140	280		
Turn-off delay time	t <sub>d(off)</sub>		-	51	100		
Fall time	t <sub>f</sub>		-	15	30		
Drain-Source Body Diode Characterist	ics						
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C -	-	94.5			
Pulse diode forward current	I <sub>SM</sub>		-	-	350	A	
Body diode voltage	$V_{SD}$	$I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.72	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	60	120	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	91	180	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25  ^{\circ}C$	-	30	-	ns	
Reverse recovery rise time	t <sub>b</sub>		-	30	-		

#### **Notes**

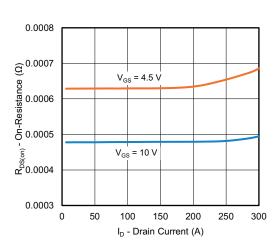
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

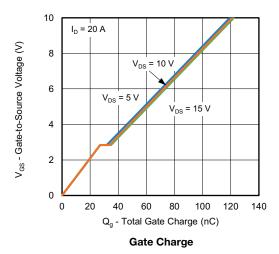


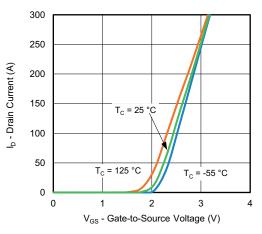


#### **Output Characteristics**

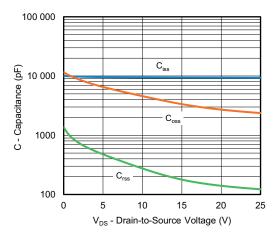


On-Resistance vs. Drain Current and Gate Voltage

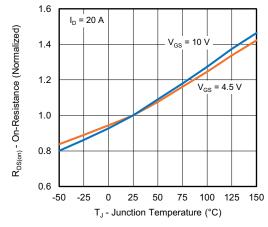




**Transfer Characteristics** 

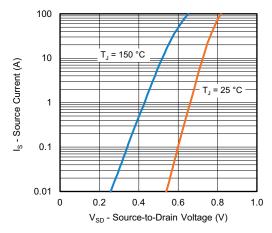


Capacitance

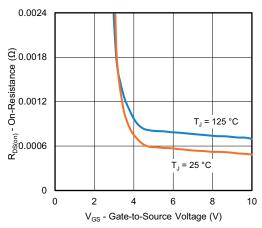


On-Resistance vs. Junction Temperature

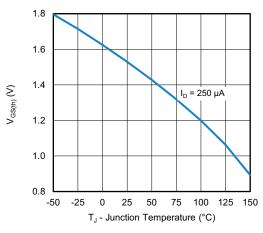




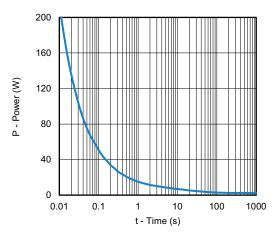
#### Source-Drain Diode Forward Voltage



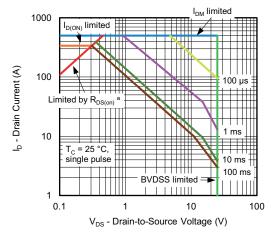
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

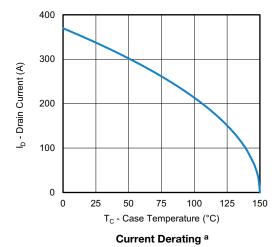


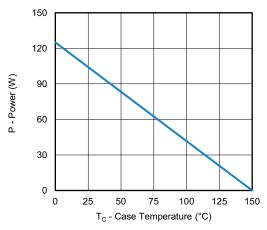
Safe Operating Area, Junction-to-Ambient

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





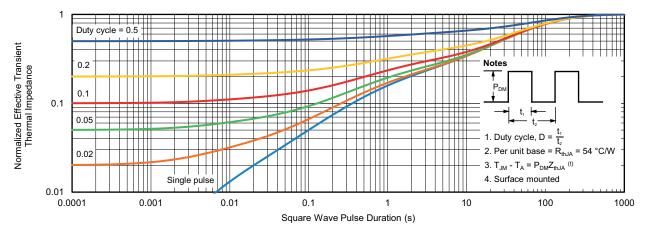


Power, Junction-to-Case

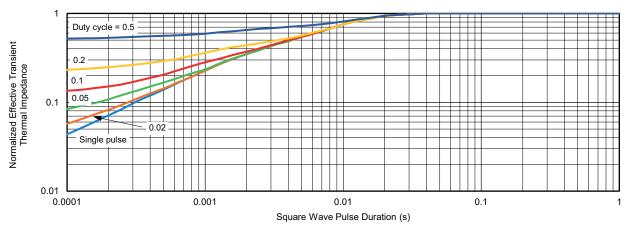
#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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